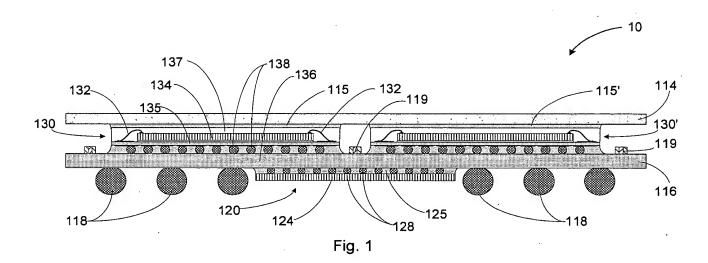
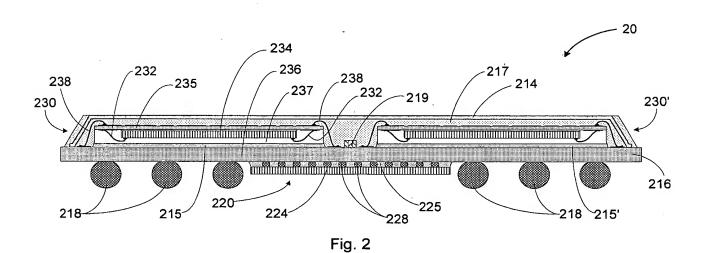
Inventor: Karnezos
Title: Semiconductor multipackage module
including processor and memory package
assemblies
Attorney Docket: CPAC 1041-2
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Inventor: Karnezos Title: Semiconductor multipackage module including processor and memory package assemblies Attorney Docket: CPAC 1041-2 Sheet 2 of 6

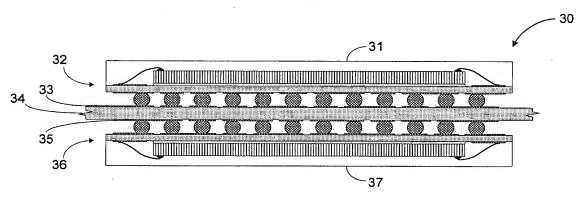


Fig. 3

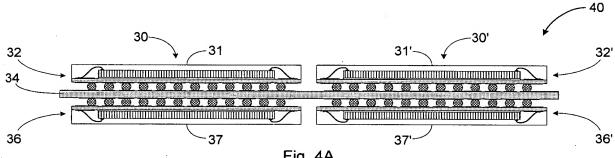
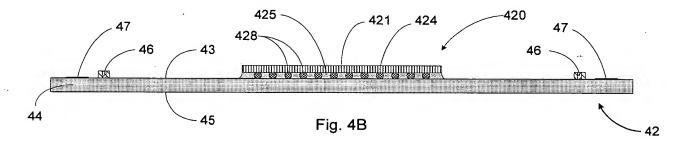
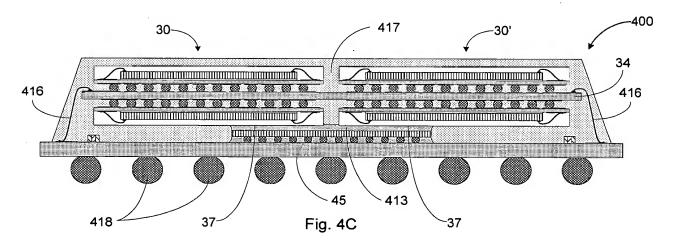


Fig. 4A



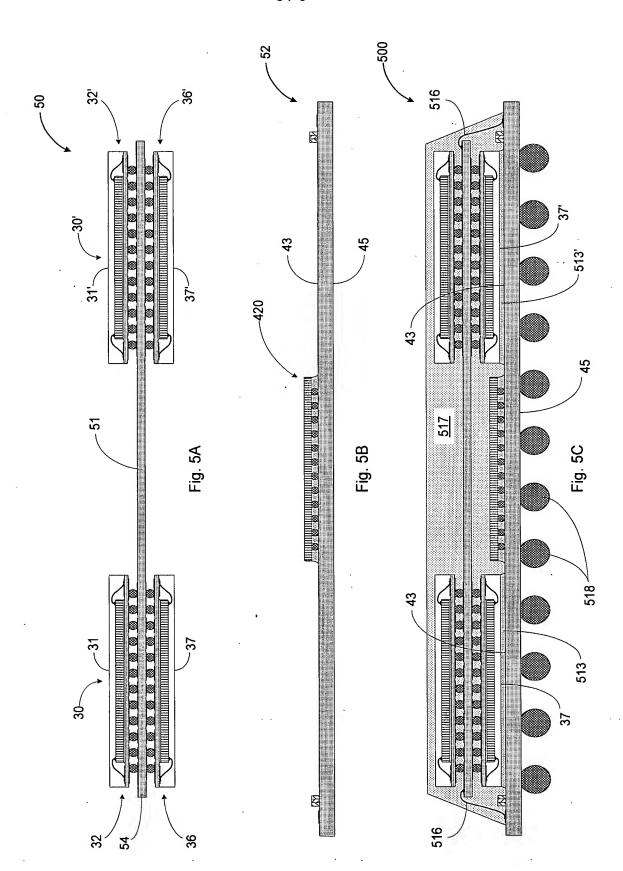


Inventor: Karnezos

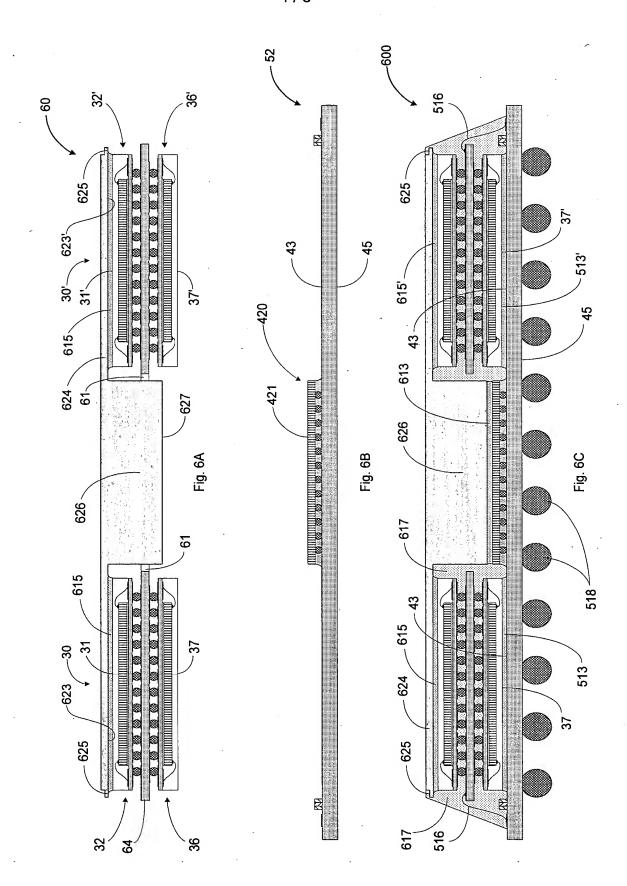
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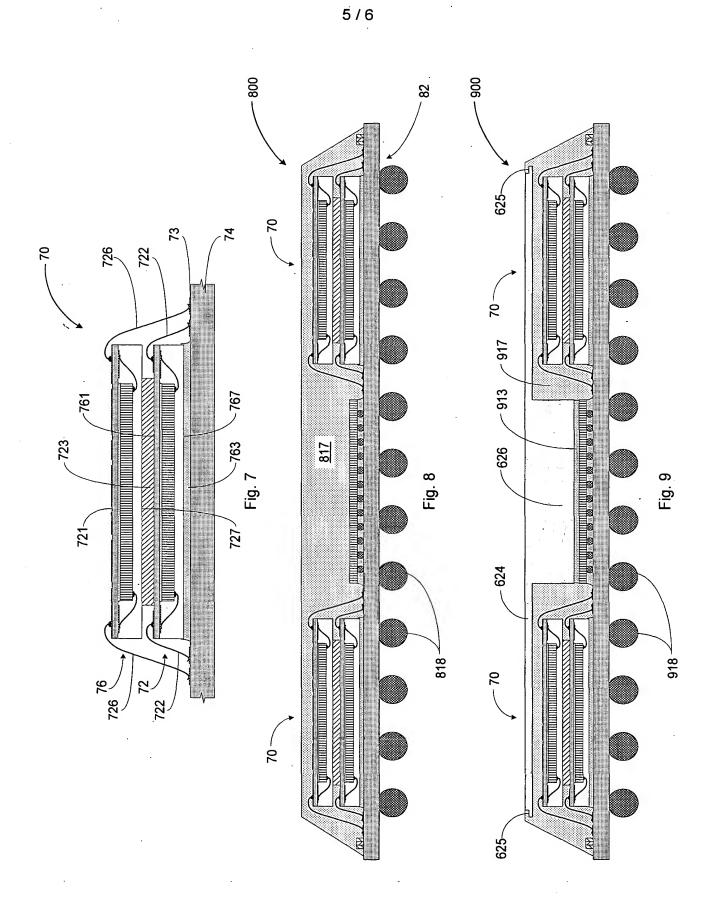


Inventor: Karnezos
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